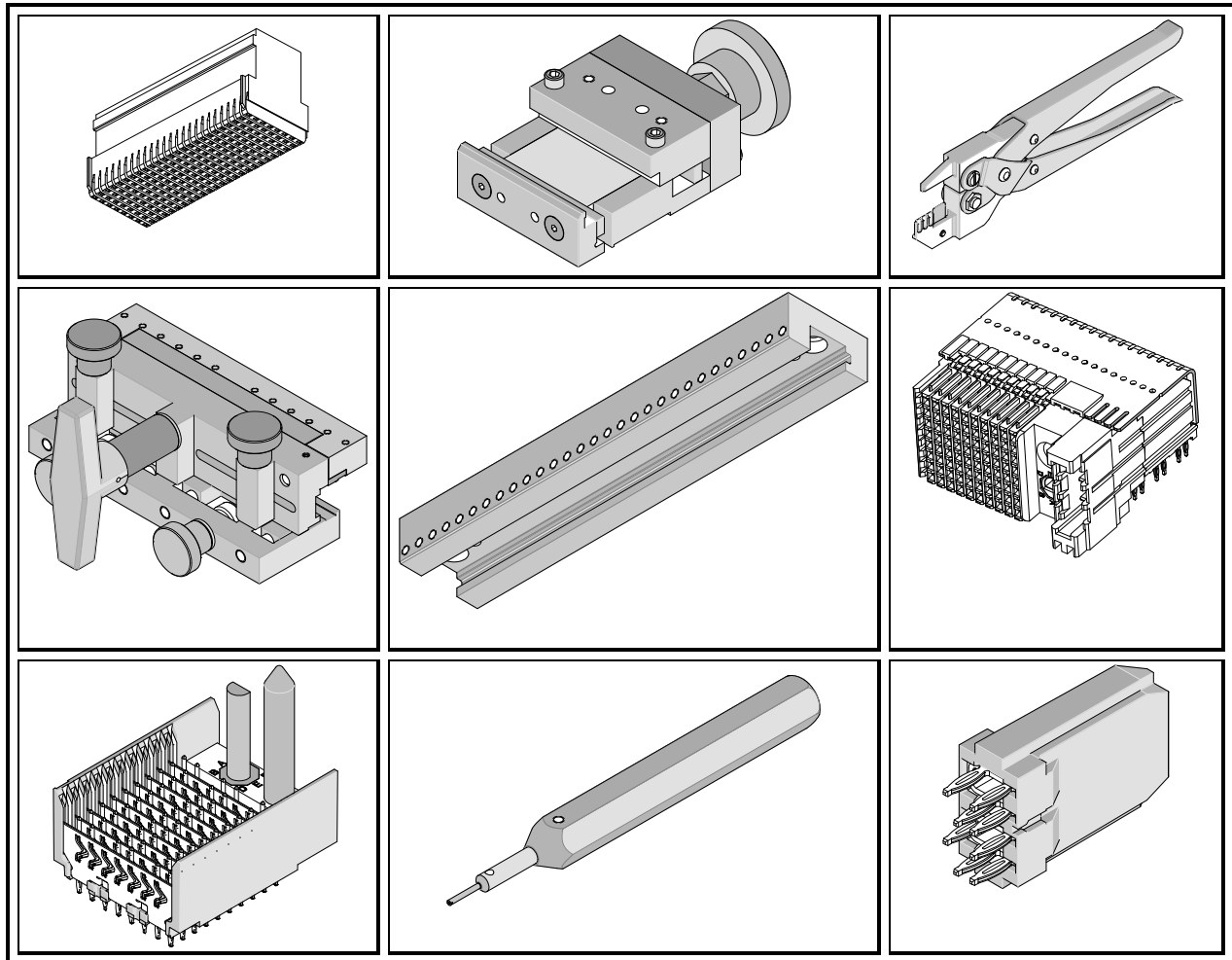


Molex 74058-9002 PDF

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**VHDM® AND VHDM-HSD™
 INSTALLATION and REPAIR TOOLING
 Operation Manual
 Order No. 62201-0999**

- Description
- Operation
- Maintenance

WARNING

NEVER OPERATE, SERVICE, INSTALL, OR ADJUST THIS TOOL WITHOUT PROPER INSTRUCTION AND WITHOUT FIRST READING AND UNDERSTANDING THE INSTRUCTIONS IN THIS MANUAL.

WORK SAFELY AT ALL TIMES

**For Service, Contact Your
Local Molex Sales Office**

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Fax: 630-505-0049

Visit our Web site at <http://www.molex.com>

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- B Instruction Sheets for Repair Tools
- C Parts Lists and Drawings for Customer Specials
- D Product Specifications

Section 1

General Description and Available Presses

- 1.1 Description
- 1.2 Features
- 1.3 Technical Specifications
- 1.4 Delivery Check
- 1.5 Tools
- 1.6 Press Requirements

General description

1.1 Description

This manual covers the tooling available to press Molex VHDM and HSD Back plane Power Modules, Back plane Connectors, and Daughter Card Modules into printed circuit boards. Repair tools and custom tools are also covered. The tooling is designed to go into a flat platen press. Operation is simple: Position a printed circuit board on the customer supplied support. Then manually insert a connector(s) into the pc board. Position the loading head into the connector. Actuate the press to press the connector pins into the board.

1.2 Features

The press-in tooling is designed so that one module will press in one connector, or several modules can be mounted in a tool holder and be used to press in any combination of connectors in one operation. See Section 1.8 (Ordering Instructions) for details.

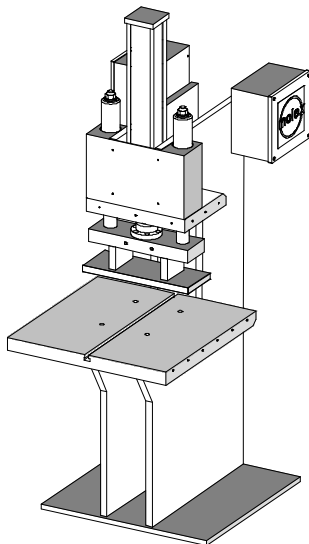


Figure 1-1
62201-3800 8-TON PRESS

1.3 Technical Specifications

Dimensions and Weight

The dimensions and weight depend on the tooling used and the size of the pc board support. The dimensions and weights of the various tooling components are given in the assembly drawings in Appendixes A, B, and C.

Rate

90 connectors pressed in (one at a time) per hour depending on operator skill.

1.4 Delivery Check

Carefully remove the tooling from its shipping container and check to be sure what was received matches the purchase order and no damage has occurred.

1.5 Tools

A metric hex wrench set will be required to assemble or disassemble tooling mounted in rails.

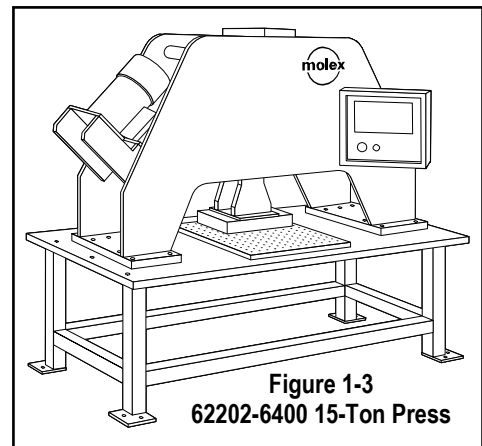


Figure 1-3
62202-6400 15-Ton Press

Molex Presses

Molex offers two (2) presses that are suitable for this application. (See also Figure 1-1 and 1-2. They are:

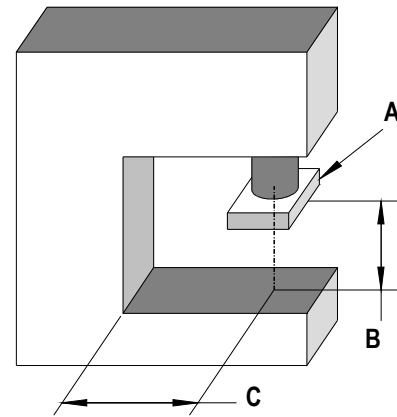
62201-3800	8-ton Pneumatic Flat Platen Press
62200-6400	15-ton Electric Flat Platen Press

1.6 Press Requirements

This tooling is designed to fit in a flat platen (or flat rock) press, capable of 66N (15 lbs) of force per pin.

Letter Description Dimension (min)
See Figure1-3.

A	Upper Platen	51mm by 102mm by 25.4mm (2" by 4" by 1")
B	Opening	89mm (3.5")
C	Throat	50mm (6")



**Figure 1-3
PRESS THROAT DIMENSIONS**

Section 2

Installation and Operation

- 2.1 Backup for printed circuit boards
- 2.2 Press stroke adjustment
- 2.3 Installation
- 2.4 Operation

2.1 Printed Circuit Board Support

The HSD / VHDM tooling requires up to 15 lb per pin of force to press the connectors into the printed circuit boards. Therefore, a backup or support is required to prevent damage to the printed circuit boards. The support fixture should have clearance for the connector terminals when they protrude through the underside of the printed circuit board. It is also recommended that the support fixture have locating pins. Due to the custom nature of each application, Molex does not supply support and locating fixtures, the customer normally supplies them.

The following is one simple way of making a printed circuit board support and locating fixture:

1. Locate a suitable piece of material for the backup. It should be approximately 3/4 inch thick and same size or a little larger than the printed circuit board to be used. While aluminum could be used, a rigid nonconductive material such as a phenolic is preferred. (A stack of scrap p.c. boards of suitable size could be fastened together and used.)
2. Obtain a scrap p.c. board like the ones to be assembled. Attach this board to the material from step 1.
3. Using an oversize drill bit, drill through each hole where a pin from the connector will go. Drill deep enough into the lower material to be certain the pins do not bottom out when inserted (at least 5mm [0.20in] deep).
4. Locate two (2) holes on the p.c. board to use as locating points. Drill for and mount suitably sized dowel pins in these two locations on the support fixture.
5. Clear out the support for any components mounted on the underside of the printed circuit board.
6. Place a p.c. board on top of the support, located by the two pins, and check that the holes for the connector pins are aligned.
7. Pre-insert a connector in the p.c. board in the correct position.
8. Insert the press-in tool of proper size into the connector.
9. Place the support with p.c. board under the press ram.

10. Press the connector into the p.c. board and observe for any deflection of the board when the ram is at the bottom of its stroke.

2.2 Press Stroke Adjustment

Most presses have some means of adjusting the stroke; please refer to the appropriate manual (for the press being used) for press stroke adjustments. The stroke should be adjusted so that when the press ram stops in the down position, the bottom of the connector is flush to .155mm (.006 in.) above the surface of the printed circuit board.

See Figure 2-1.

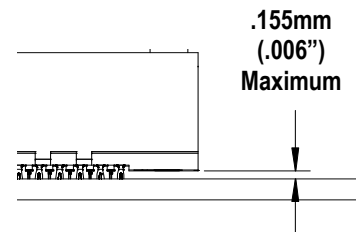


Figure 2-1
MAXIMUM CLEARANCE WHEN
CONNECTOR FULLY SEATED

2.3 Installation

The only installation required is when you need to install insertion modules into a tooling holder. To do this, use the following procedure:

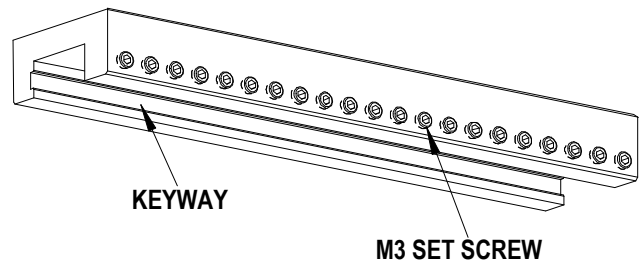


Figure 2-2
TOOLING HOLDER

1. Along the lower edge of the tooling holder is a row of M3 set screws, back these out so that they do not protrude into the inside of the holder. See Figure 2-2.
2. Slide the insertion modules into the tooling holder in the proper order. See Figure 2-3. The modules are keyed so that they cannot be put in backwards.

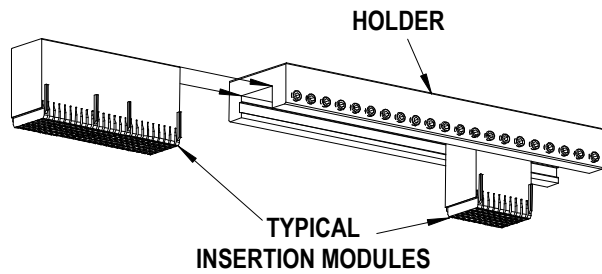


Figure 2-3
MOUNTING INSERT MODULE
IN A MOUNTING BLOCK

- Now tighten the M3 set screws against the modules with one (1) screw against each power module inserter and each alignment block; and two (2) screws evenly spaced on a 6 by 10 header insertion module; and at least three (3) screws evenly spaced on a 6 by 25 header insertion module. Figure 2-4 shows a typical completed assembly.

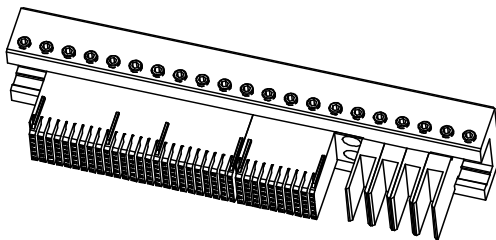


Figure 2-4
TYPICAL INSERTION TOOL ASSEMBLY

2.4 Operation

Header insertion Tooling

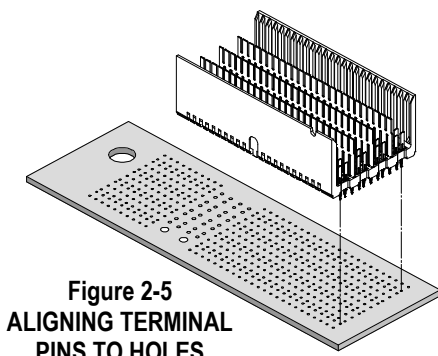


Figure 2-5
ALIGNING TERMINAL
PINS TO HOLES

- Carefully locate the connector(s) on the printed circuit board and start in by hand. Make sure pin 1 is in the correct position on all connectors. See Figure 2-5.

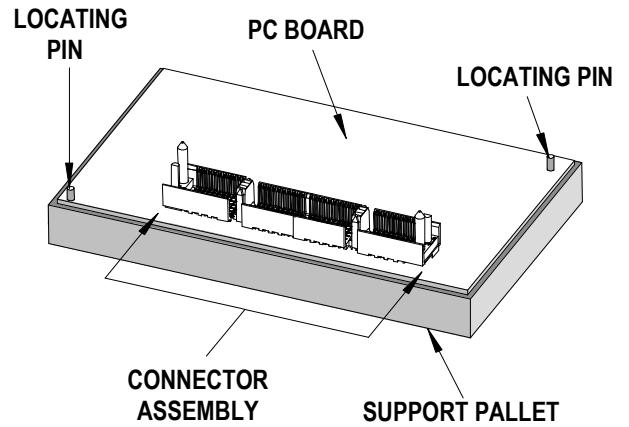


Figure 2-6
CONNECTOR ASSEMBLY
ON PC BOARD SUPPORT PALLET

- Locate the pre-loaded board into the support pallet. See Figure 2-6.
- Locate the tooling assembly in the connector assembly, carefully checking alignment. See Figure 2-7.
- Position the pre loaded support pallet under the press platen.

CAUTION: Do not over tighten the setscrews as you could damage the insertion tool.

NOTE: See Section 4 for details on selecting modules and mounting blocks.

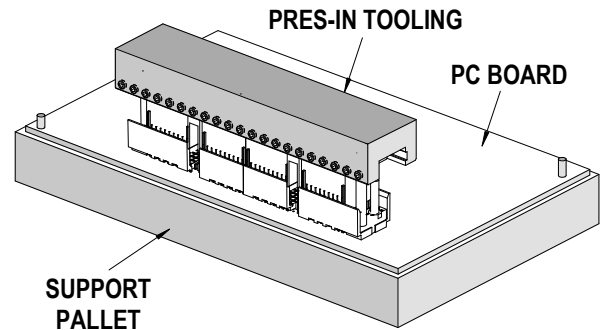


Figure 2-7
TYPICAL HEADER ASSEMBLY
ON THE PC BOARD

- Cycle the press. See Section 2.1 for press stroke adjustment.
- Remove the loaded support pallet.
- Carefully remove the insertion tool assembly.
- Remove the printed circuit board.

Daughter Card Tooling

Operation for inserting Daughter Card assemblies is different because Daughter Card connectors are available only in complete assemblies held together with a stiffener rail; so therefore, insertion tooling is only determined by the total assembly length. The insertion module is 100mm long and can be used alone or stacked in a tool holder for larger connector assemblies.

1. Locate the Daughter Card connector assembly on the printed circuit board.
2. Start the assembly into the board by hand. See Figure 2-8.
3. Locate the printed circuit board with the connector assembly on the customer supplied support pallet.
4. Position the insertion tooling on the connector assembly. See Figure 2-9.
5. Position the p.c. board and support fixture under the press platen.
6. Cycle the press.
7. Remove the loaded support pallet from the press.
8. Remove the insertion tool.
9. Carefully remove the assembled printed circuit board from the support pallet.

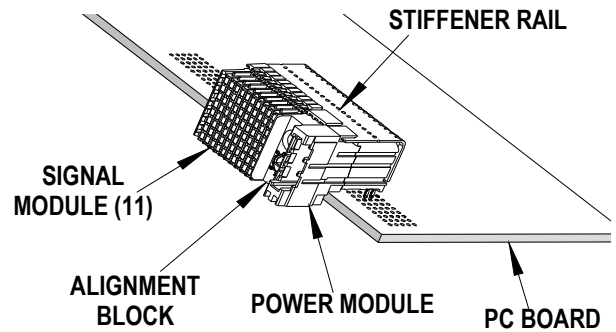


Figure 2-8
TYPICAL DAUGHTERCARD ASSEMBLY
ON THE PC BOARD

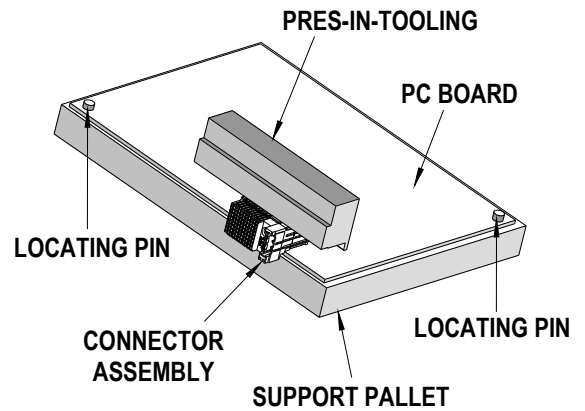


Figure 2-9
PB BOARD, CONNECTOR, AND TOOLING ON
SUPPORT PALLET READY FOR PRESS

Section 3

MAINTENANCE

- 3.1 Cleaning
- 3.2 Spare Parts
- 3.3 Perishable Parts
- 3.4 Preventive Maintenance
- 3.5 Troubleshooting

3.1 Cleaning

Once a day, the support fixture should be cleaned of dust and plating particles and other debris. Compressed air may be necessary to remove debris from the pin clearance holes.

CAUTION: Use **extreme caution** when using compressed air for cleaning as it can cause debris to get lodged in the tooling, and fly out at the operator. **USE** of proper safety glasses by the operator and onlookers is required.

Lubrication

There is no lubrication required on any of the HSD / VHDM tooling. However, the presses each have their own requirements for lubrication and maintenance. The instruction manual for the specific press being used should be referred to. Molex provides a sheet for logging routine preventive maintenance in this section.

3.2 Spare parts

Spare parts are parts that are available to support the HSD / VHDM Tooling in service. They are moving or otherwise functioning parts that could be damaged or malfunction. Molex Application Tooling Group recommends that the customer keep some or all of these parts on hand to reduce down time. These parts are identified in the Parts Lists in Appendices A, B, and C.

3.3 Perishable Parts

Perishable parts make contact with the product and can wear over time. The customer is responsible for maintaining these parts and Molex recommends that they keep at least one spare set on hand at all times. These parts are identified in the Parts Lists in Appendices A, B, and C.

3.4 Preventive Maintenance

DAILY: Clean, See Section 3.1.1

MONTHLY: Lubricate, See Section 3.1.2

CHECK SHEET MONTH _____ YEAR _____

Week	Daily Use	Days of the Week							Solution
		MON	TUE	WED	THU	FRI	SAT	SUN	
1									
2									
3									
4									
Cleaning	Daily								
Lubricate	Monthly								

Chart may be copied for mounting.

Schedules should be adjusted up or down depending on usage. Molex Application Tooling Group recommends that a log of preventive maintenance be kept with the machine.

3.5 Troubleshooting

Symptom	Cause	Solution
Connector Being Damaged	<ul style="list-style-type: none"> ▪ Press stroke set too low. 	Refer to the appropriate press manual and adjust the stroke. See Section 2.2.
	<ul style="list-style-type: none"> ▪ Something not properly aligned. 	Check fixture and repair as required.
		Check alignment of fixture in press. Check to be sure the press platen is pressing squarely on the tooling block.
	<ul style="list-style-type: none"> ▪ "Blades" on tooling bent or damaged. 	Replace tool.

Section 4

Available Tools

4.1 Standard Press-In-Tools

Table 4-1 Assembly Tooling for VHDM Signal Headers

Table 4-2 Assembly Tooling for HSD and VHDM Daughter Card Receptacles

Table 4-3 Standard Tool Holder for Back Plane Header Assembly

Table 4-4 Assembly Tooling for 8 Row VHDM Signal Headers

Table 4-5 Old Style Tool Holders for Back Plane Header Assembly

Table 4-6 Field Repair Tooling for HSD and VHDM Headers

Table 4-7 Available Repair Tools

4.2 Standard Tool Ordering Procedure

4.1 Standard Press-In-Tools

Standard Insertion Tools

All the applicable VHDM and VHDM-HSD connectors and the standard tooling required for each connector are located in these tables.

Table 4-1

Assembly Tooling for VHDM Signal Headers (For use in standard tool holders)

Refer to the individual instruction sheets for more information on Individual tools

Product Number	Tool Description	Tool Size (Long)	Illustration
VHDM Advanced Mate Signal Header (6 row by 10 wide) (74057, 74058, and 74059 Series)	Insertion Module 62202-0203	(20mm) (.787")	
VHDM Advanced Mate Signal Header (6 row by 25 wide) (74057, 74058, and 74059 Series)	Insertion Module 62202-0204	(50mm) (1.97")	
VHDM Advanced Mate Signal Header (8 row by 10 wide) (74060, 74061, and 74062 Series)	Insertion Module 62202-0205	(20mm) (.787")	
VHDM Advanced Mate Signal Header (8 row by 25 wide) (74060, 74061, and 74062 Series)	Insertion Module 62202-0206	(50mm) (1.97")	
VHDM Advanced Mate Signal Header (6 row by 10 wide) (74057, 74058, 74059, and 74074 Series) (76761, 76762, and 76763 Series)	Insertion Module 62202-0207	(20mm) (.787")	
VHDM Standard Shield Signal Header (6 row by 11 wide) (74057, 74058, and 74059 Series)	Insertion Module 62201-1101	(20mm) (.787")	
VHDM Standard Shield Signal Header (6 row by 13 wide) 74057, 74058, and 74059 Series)	Insertion Module 62201-0905	(26mm) (1.02")	
VHDM Standard Shield Signal Header (6 row by 14 wide) (74057, 74058, and 74059 Series)	Insertion Module 62201-0904	(28mm) (1.10")	
VHDM Standard Shield Signal Header (6 row by 25 wide) (74057, 74058, 74059, and 74074 Series) (76761, 76762, and 76763)	Insertion Module 62202-0208	(50mm) (1.97")	
VHDM Standard Shield Signal Header (8 row by 10 wide) (74060, 74061, 74062, and 74075 Series) (76134, 76135, and 76136 Series)	Insertion Module 62202-0209	(20mm) (.787")	

Product Number	Tool Description	Tool Size (Long)	Illustration
VHDM Standard Shield Signal Header (8 row by 25 wide) (74060, 74061, 74062, and 74075 Series) (76134, 76135, and 76136 Series)	Insertion Module 62202-0210	8 by 25 (50mm) (1.97")	
VHDM Power module 74029-6000 (6 row) 74029-8000 (8 row)	Insertion Module 62202-0211	5.4mm (.212")	
VHDM and VHDM-HSD Signal Headers all sizes with guide pins	Alignment Block 62202-0212	7.0mm (.276")	
VHDM-HSD Signal Header (5 row by 10 wide) (74695, 74696, 74697, 74701 and 74702 Series)	Insertion Module 62202-0201	(20mm) (.787")	
VHDM-HSD Signal Header (5 row by 25 wide) (74695, 74696, 74697 and 74702 Series)	Insertion Module 62202-0202	(50mm) (1.97")	
VHDM-HSD Signal Header (6 row 10 wide) (74979, 74980, and 74981 Series)	Insertion Module 62202-0216	(20mm) (.787")	
VHDM-HSD Signal Header (6 row by 25 wide) (74679, 74680, and 74681 Series)	Insertion Module 62202-0217	(50mm) (1.97")	
VHDM-HSD Signal Header (8 row 10 wide) (74649, 74650, and 74651 Series)	Insertion Module 62202-0205	8 by 10 (20mm) (.787")	
VHDM-HSD Signal Header (8 row by 25 wide) (74649, 74650, and 74651 Series)	Insertion Module 62202-0206	8 by 25 (50mm) (1.97")	

Table 4-2

Assembly Tooling for HSD and VHDM (Daughter Card Receptacles)

Product Number	Tool Description	Tool Size (Long)	Illustration
VHDM-HSD 5-row Assembly (74670 Series) VHDM 6-row Assembly (74030 Series) VHDM-H 6-row Assembly (76760 Series)	Insertion Module 62202-0213	100mm (3.94")	
VHDM 6-row Assembly (Right Angle Male) (74600 Series)	Insertion Module 62202-0215	100mm (3.94")	
VHDM 8 row Assembly (74040, 74680, 74686, and 76021 Series) GbX 4-Pair (75220, 75420, 75426, 75878 Series) HSD 8-row Assembly (74680 Series) Hybrid 8-row Assembly (74686 Series)	Insertion Module 62202-0214	100mm (3.94")	

Table 4-3

Standard Tool Holder for Back Plane Header Assembly

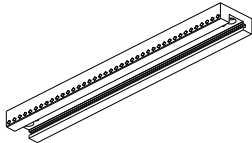
Module Number	Tool Description	Tool Length	Illustration
VHDM and HSD Insertion modules: 62202-0201 to 62201-0214 and Old style VHDM 6 row Insertion modules: 62201-0901, 62201-1001, 62201-1101, and 62201-1601	Tool Holder for Backplane Assembly. Tooling 62201-9501	24mm (0.94")	
	Tool Holder for Backplane Assembly. Tooling 62201-9502	72mm (2.83")	
	Tool Holder for Backplane Assembly. Tooling 62201-9503	156mm (6.14")	
	Tool holder for Backplane Assembly. Tooling 62201-9504	216mm (8.50")	
	Tool holder for Backplane Assembly. Tooling 62201-9509	254mm (10.00")	
	Tool Holder for Backplane Assembly. Tooling 62201-9511	304.8mm (12.00")	
	Tool holder for Backplane Assembly. Tooling 62201-9512	406.4mm (16.00")	

Table 4-4

Assembly Tooling for 8 Row VHDM Signal Headers (For use in standard tool holders)


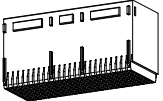
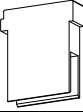
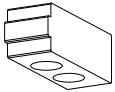
Product Number	Tool Description	Tool Length	Illustration
VHDM Std. Shield Signal Header (8 row by 10 wide) (74060, 74061, and 74062 Series)	Old style Insertion Module 62201-1301 OBSOLETE	8 by 10 (20mm)	
VHDM Std. Shield Signal Header (8 row by 25 wide) (74060, 74061, and 74062 Series)	Old style Insertion Module 62201-1201 OBSOLETE	8 by 25 (50mm)	
VHDM 8 row Power module 74029-8000	Old style Insertion Module 62201-1401 OBSOLETE	5.4mm	
VHDM 8 row Std. Shield Signal headers with guide pins	Alignment Block for old style 8 row header 62201-1302 OBSOLETE	7mm	

Table 4-5
Old Style Tool Holders for Back Plane Header Assembly

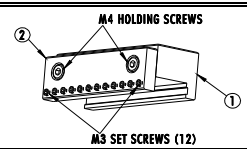
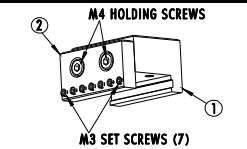
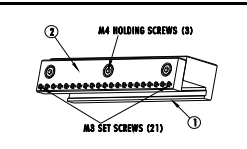
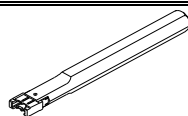
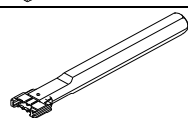
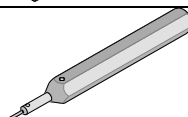
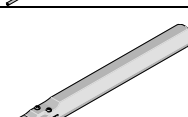
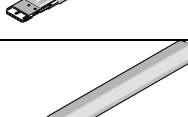
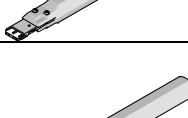
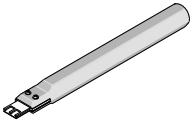
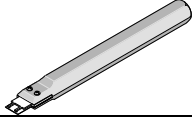
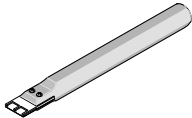
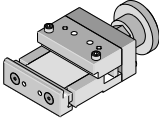
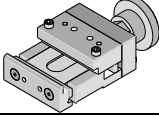
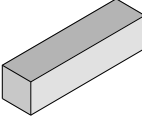
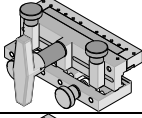
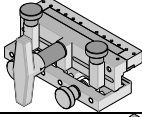
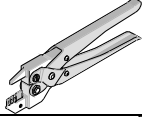
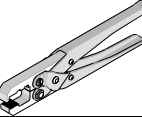
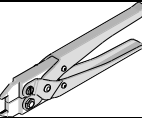
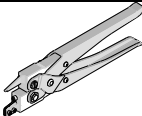
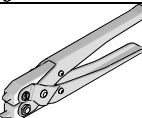
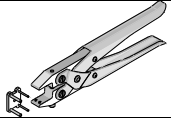
Module Number	Tool Description	Tool Length	Illustration
Old style VHDM 8 row Insertion modules: 62201-1201, 62201-1301, and 62201-1401	8 Row Tool Holder for Backplane Assembly. Tooling 62201-1200	65mm (2.56")	
	8 Row Tool Holder for Backplane Assembly. Tooling 62201-1300	36mm (1.42")	
NOTE: Use with 8 row alignment block 62201-1302 when signal headers with guide pins are used	8 row Tool Holder for Backplane Assembly. Tooling 62201-1800	115mm (4.53")	

Table 4-6
Field Repair Tooling for VHDM and HSD Headers

This table lists the special tools designed for use in repairing damaged VHDM and HSD connectors that are mounted on a printed circuit board.

Product Number	Tool Description	Illustration
VHDM Power Module Insulator 6-row by 2 circuit (74029 Series)	6 row Power Insulation Inserter Repair Tool 62100-3500	
VHDM Power Module Insulator 8 row by 3 circuit (74029 Series)	8 row Power Insulation Inserter Repair Tool 62100-3600	
VHDM and HSD Signal pins (All sizes)	Single Pin Inserter Repair Tool 62201-5700	
VHDM Headers: 6-row (74057, 74058, and 74059 Series) VHDM-H 6-row (76761, 76762, and 76763 Series)	6-row Pin and Shield Repair Tool 62201-5800	
HSD Headers: 5 row (74695, 74696, and 74697 Series)	5 row Pin and Shield Repair Tool 62201-5810	
VHDM Headers: 8 row (74060, 74061, and 74062 Series) HSD Headers: 8 row (74649, 74650, and 74651 Series) VHDM-H (76134, 76135, and 76136)	8 row Pin and Shield Repair Tool 62201-5900	

Product Number	Tool Description	Illustration
VHDM Headers: 6 row (74057, 74058, and 74059 Series) VHDM-H 6-row (76761, 76762, and 76763 Series)	6 row Shield Extraction Tool 62201-6000	
HSD Headers: 5 row (74695, 74696, and 74697 Series)	5 row Shield Extraction Tool 62201-6010	
VHDM Headers: 8 row (74060, 74061, and 74062 Series) HSD Headers: 8 row (74649, 74650, and 74651 Series) VHDM-H (76134, 76135, and 76136)	8 row Shield Extraction Tool 62201-6100	
Daughter Card Receptacle VHDM 6-row Assembly (74030 and 76760 Series) VHDM 8-row Assembly (74040 and 76021 Series) HSD 8-row Assembly (74680 Series)	6 and 8 row Stiffener Removal tool 62201-6200	
Daughter Card Assembly HSD 5 row Assembly (74670 Series)	5 row Stiffener Removal tool 62201-6215	
Daughter Card Assembly VHDM and HSD (74030, 74040, 74670, and 74680 Series)	Press Block Removal tool 62201-6250	
Ram Assembly (74600 and 75286 Series)	Stiffener Removal tool 62202-1000	
VHDM Right Angle Male 8 Row Ram (75165 and 75346 series)	Stiffener Removal Tool 62202-1700	
VHDM Right Angle Male Header (74600 Series)	Single Wafer Removal Tool 62202-1050	
VHDM Right Angle Male Header (74600 Series)	Single Wafer Insertion Tool 62202-1060	
VHDM 8 Row Stacker Assembly (75118 Series)	Single Wafer Removal Tool 62202-1450	
VHDM Right Angle Male Header (74030, 74040, 74670, and 74680 Series)	Single Wafer Removal Tool 62100-4300	
VHDM and HSD (74039 Series)	Joiner / Ground Insertion Tool 62100-3800	

Product Number	Tool Description	Illustration
VHDM and HSD (73892 Series)	Latch Insertion Tools 62100-3915, 62100-3925 and 62100-3935	

4.2 Standard Tool Ordering Procedure

Stacking Tooling

All the insertion tooling listed in Table 4-1 and 4-2 can be stacked in any combination to be able to simultaneously press in any arrangement of stacked connectors. Tooling holders are available in various lengths. Figure 4-1 shows a typical setup for a 6 by 25 signal module, a 6 by 10 signal module, and four (4) 6-row power modules.

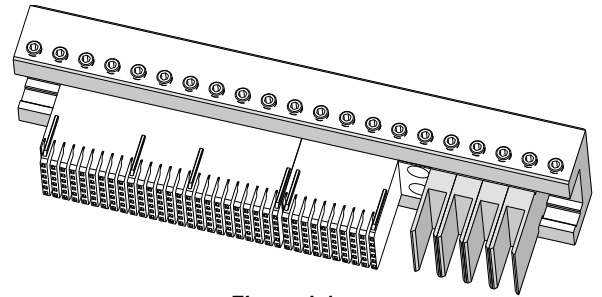


Figure 4-1
TYPICAL TOOLING COMBINATION

Ordering Tooling for Connectors

In order to insert a typical row of connectors, it is necessary to select the individual insertion tools and then pick the appropriate tooling holder, (See also examples 1 and 2).

Basic Procedure

- 1 Determine the combination of signal modules and power modules to be inserted.
- 2 Select the proper insertion modules from Table 4-1 and Table 4-2. Remember to include the appropriate alignment block(s).
- 3 Table 4-1 and Table 4-2 shows the tool sizes. (Long) Write down the length of each tool selected.
NOTE: Make sure that if you require four of a particular tool, write down its length 4 times.
- 4 Total up these lengths.
- 5 Using the length just calculated, select the next largest tooling holder from Table 4-3. The tooling holder can be shorter than the total tooling but not by more than 0.5 mm per side.
- 6 All of the tools selected above must be ordered separately.

Example 1

To be inserted: (1) 74059-2501 (6 by 25) Backplane Signal Module and (1) 74029-XXXX Power Module.

1. Look at Table 4-1 and find the required tools. In this case it would be a 62202-0208 and a 62202-0211.
2. From Table 4-1 get the lengths of these tools (numbers may be rounded up); 62202-0208 = 50.0mm and 62202-0211 = 5.4mm.
3. Add these two values for a total of 55.4mm.
4. From the Tooling Holder list in Table 4-3, pick the 72mm long holder, 62201-9502.
5. Thus the order to Molex should include the following:

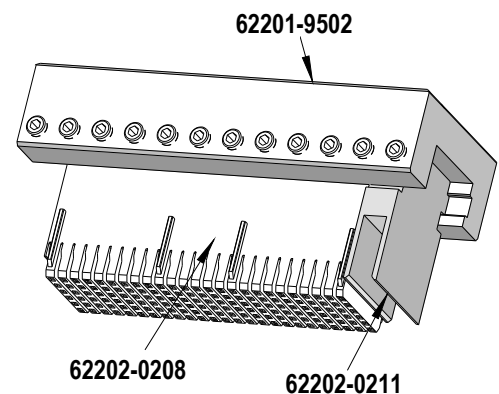


Figure 4-2
Example 1 TOOL ASSEMBLY

Quantity	Order No.	Description
1	62202-0208	6 by 25 Header Insertion Module
1	62202-0211	Power Connector Insertion Module
1	62201-9502	72mm Long Tooling Holder

(Figure 4-2 shows the assembled unit.)

Example 2

The following combination is to be inserted:

- (1) 74058-2501 6 by 25 Signal Module with locating pins on the left;
- (1) 74059-1001 6 by 10 Signal Module with locating pins on the right;
- (4) 74029-6000 6 row power modules.

1. From the tooling list in Table 4-1 pick a 62202-0208 for the first module.
2. A 62202-0207 will be needed for the second module.
3. Pick one (1) 62202-0212, to act as a spacer to accommodate the locating pin on the 62202-0207.
4. Now pick four (4) 62202-0211-power module tools.
5. Get the length information from Table 4-1 (some rounded up a little).
6. Total up the lengths;

62202-0208	50.0mm
62202-0207	20.0mm
62202-0212	7.0mm
62202-0211	5.4mm
62202-0211	5.4mm
62202-0211	5.4mm
62202-0211	5.4mm
Total = 98.6mm	

1. Using this total length, pick the 62201-9503 Tooling Holder (Table 4-3) as this is 156mm long.
2. Therefore the purchase order should contain the following:

Quantity	Order No.	Description
1	62202-0212	Alignment Block
1	62202-0208	6 by 25 Header Insertion Module
1	62202-0207	6 by 10 Header Insertion Module
4	62202-0211	Power Module Inserter
1	62201-9503	6 Row, 156mm Long Tooling Holder

(Figure 4-3 shows the assembled insertion tooling.)

Ordering Daughter Card Tooling

Daughter Card connectors only come in custom assemblies that are loaded in a stiffener rail. The daughter card insertion modules are 100 mm long. Therefore, insertion tools can be used individually for connector assemblies that are shorter than 100mm. or stacked in a tool holder for connector assemblies that are longer.

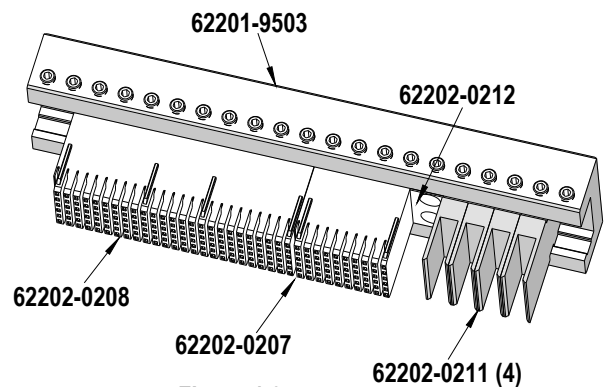


Figure 4-3
Example 2 TOOL ASSEMBLY

Basic Procedure

1. Determine the combination of signal wafers, power modules, and guidance modules to be inserted.
2. Determine the total length of the stack of components.
3. Using that length, select the daughter card insertion tools required to cover the whole connector assembly. If more than one 100mm module is used, a tool holder of appropriate length will be needed. This can be selected from Table 4-1.

Example 3

Sixty (60) 74041-0001 8-row daughter card signal wafers, two (2) 74026-8321 8-row power modules and two (2) 74037-0001 8-row guidance modules are to be stacked on a stiffener and inserted.

1. From Table 4-6, it is determined that the signal wafers are 2 mm long, the power modules are 6 mm long and the guidance modules are 8 mm long.
2. Add these up to get the total length:

74041-0001	2mm by 60	=	120mm
74026-8321			6mm
74026-8321			6mm
74037-0018			8mm
74037-0018			8mm
	Total		148mm

3. Using length 148mm, select the following tooling from Table 4-1:

Quantity	Order No.	Description
2	62202-0214	100mm long 8-row daughter card tool alignment block
1	62201-9504	216mm long tool holder

Section 5

Glossary of Terms

Backup Pallet	A simple fixture used to locate and support a printed circuit while a compliant pin connector is being pressed into the pc board. Considerable force is required to press one of these connectors into a pc board, thus the pc board must be adequately supported to avoid being damaged. It must have adequate clearance for the terminals when they protrude through the pc board.
Compliant Pin Connector	A connector which has terminals that are designed to give slightly when pressed into a hole in a pc board so that the terminal (pin) makes solid electrical contact with the printed circuit board, alleviating the need for soldering.
Flat Platen Press	A press in which the upper tooling or die set is not attached to the press ram. The ram has a simple flat plate (or platen) attached to it. For this application, the upper tooling is positioned in the connector(s). The press ram comes down on top this tooling and presses on it. When the press ram goes back up, the upper tooling stays with the connector.
HSD	High speed differential
VHDM	Very High Density Metric connector system: A 2mm pitch module-to-backplane connector system designed for applications requiring high interconnect density and high-speed signal integrity.
PC Board	Abbreviation for printed circuit board
Support Pallet	Same as backup pallet
Upper Tooling	The tooling that goes on top of the connector. It contains the mounting block and dies (or tools) necessary to properly apply pressure where required to push the connector terminals and locking posts into the holes in the printed circuit board.

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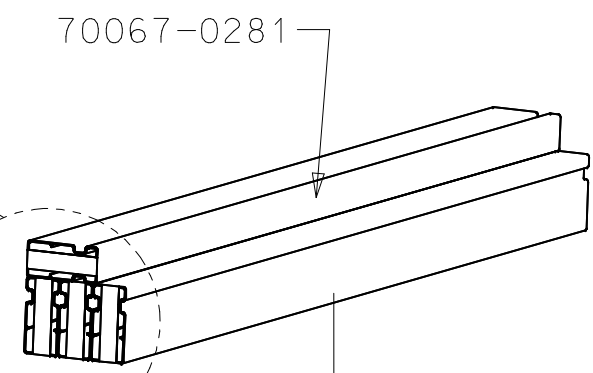
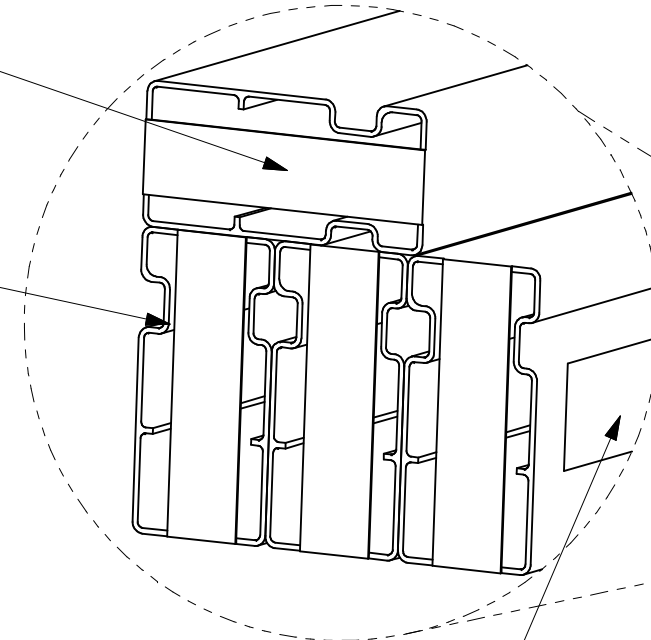
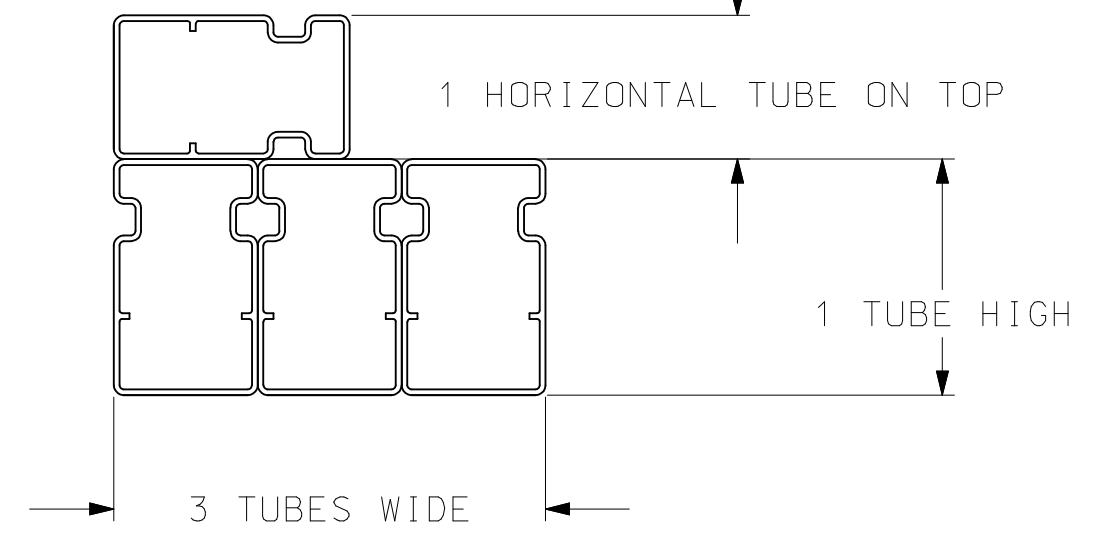
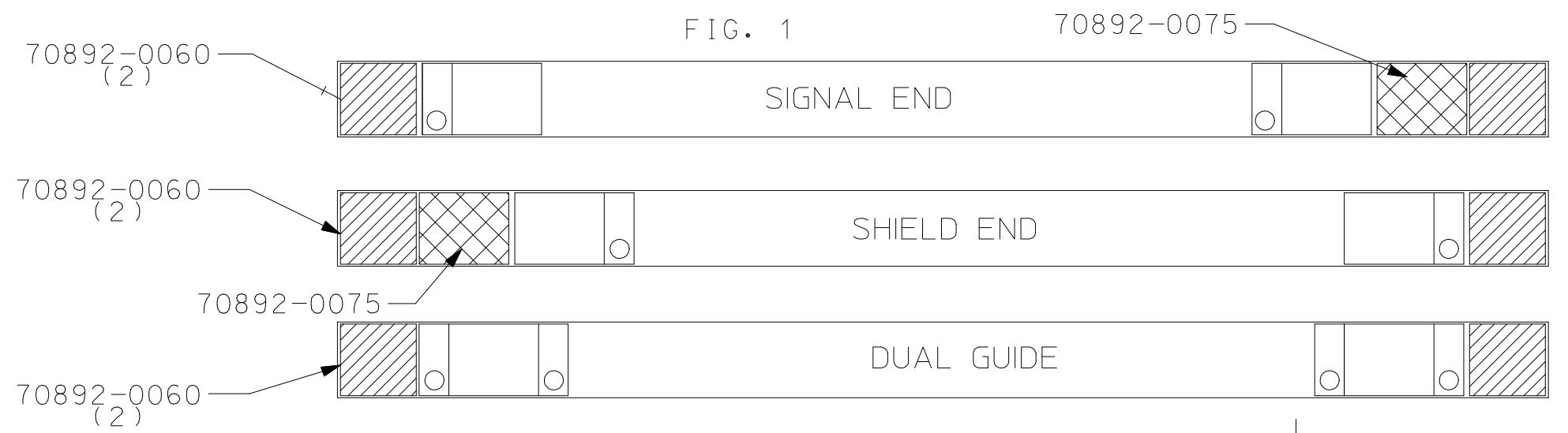
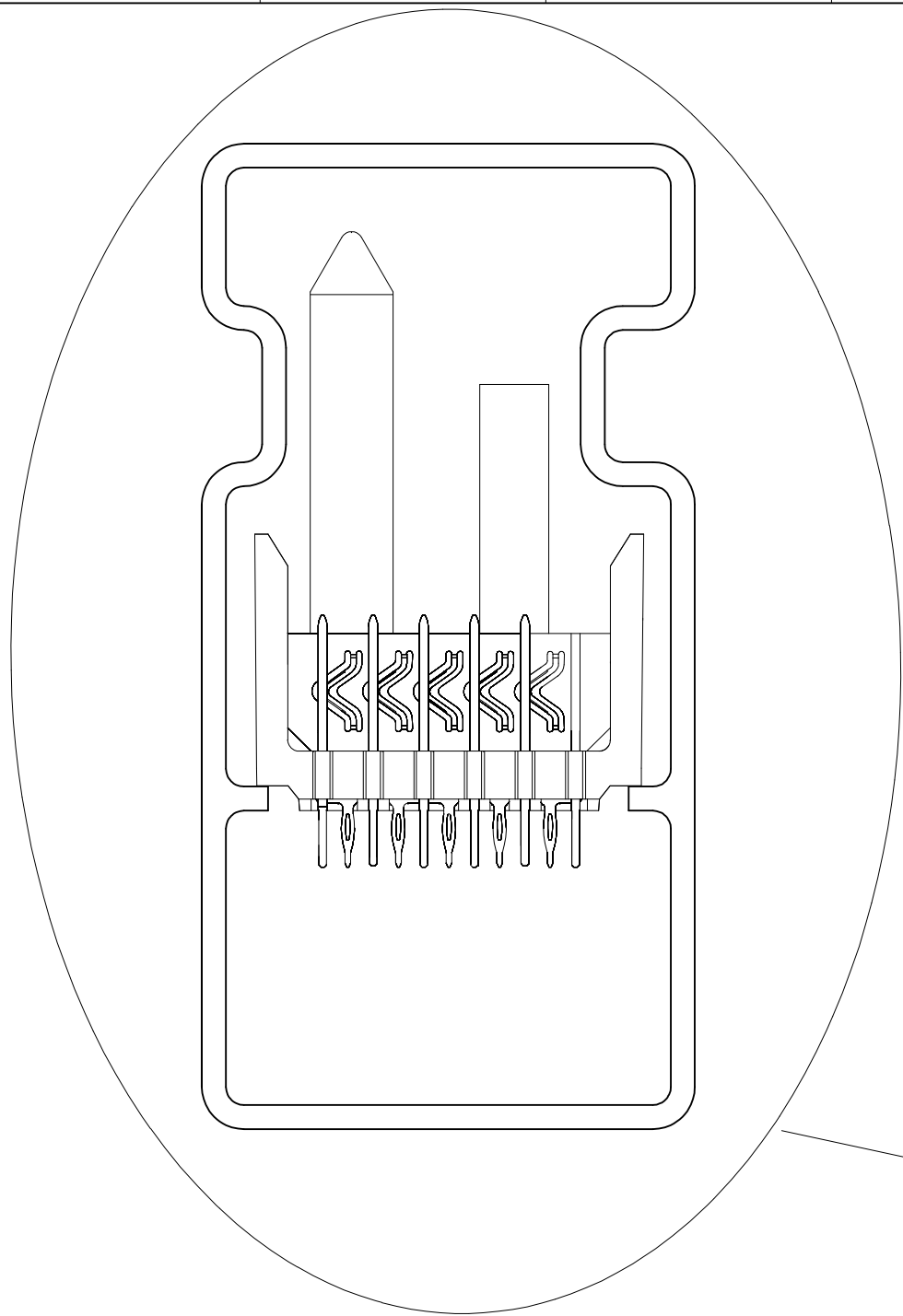
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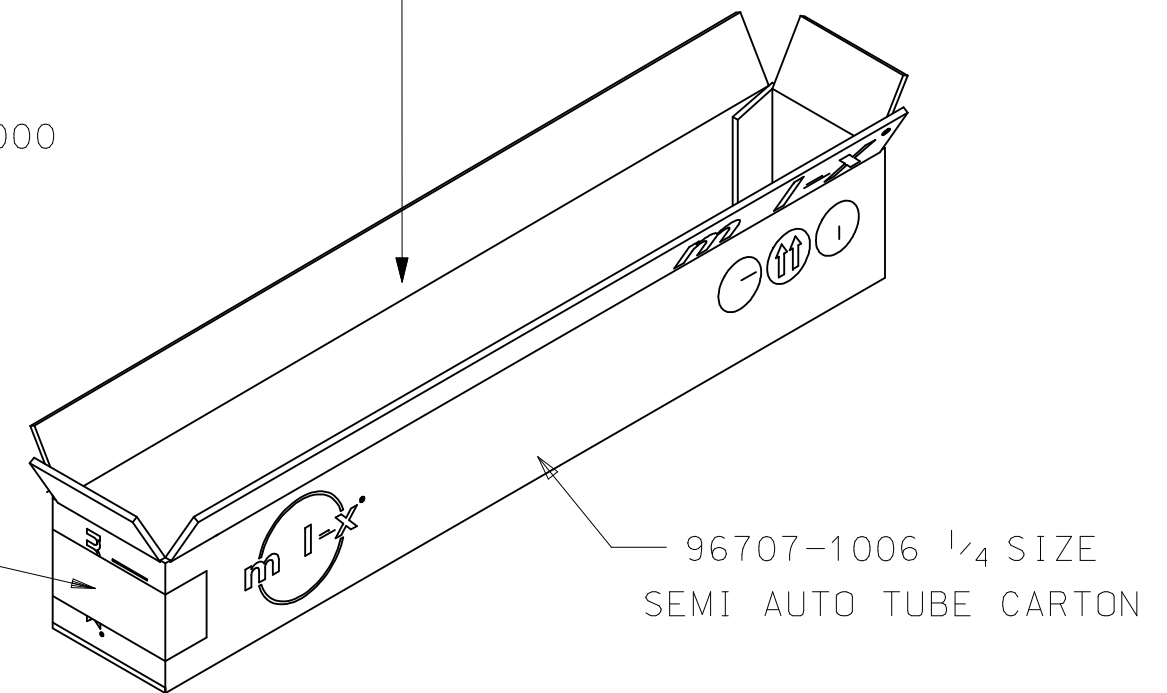
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LABEL 73728-0000
SEE NOTE #6



NOTES:

- CARTON CLOSURES MUST BE DONE WITH TAPE.
- PARTS TO BE LOADED INTO 70067-0281 TUBES AS SHOWN IN PART ORIENTATION DETAIL.
- AFTER FILLING TUBES, THE 70892-0075 PLASTIC END PLUGS AND 70892-0060 FOAM END PLUGS MUST BE INSERTED AS SHOWN IN FIG 1. ASSEMBLED TUBE LENGTHS MUST NOT EXCEED 562mm.
- TUBES MUST BE LOADED INTO 96707-1006 AS SHOWN.
- USE ONE (1) 70180-8700 WHITE TYVEK TUBE CLOSURE LABEL ON EACH END.
- MARK CUSTOM LABEL P/N 73728-0000 WITH P/N AND DATE CODE. PLACE ONE LABEL PER TUBE APPROXIMATELY WHERE SHOWN.
- FILL ALL EXCESS SPACE IN BOX WITH PINK FOAM.
- INFORMATION LABEL TO BE WRAPPED AROUND THE END OF CARTON SUCH THAT P/N AND BAR CODE ARE VISIBLE AND CENTERED ON THE END PANEL.
- SPO AND MOQ EQUAL ONE (1) 1/4 SIZE CARTON.
- ADD TWO SHEETS OF FOAM P/N 96720-0004, ONE TO EACH SIDE BETWEEN ENDS OF TUBES AND CARTON. IF FOAM DOES NOT FIT AS TUBES ARE TIGHT IN BOX FOAM IS UNNECESSARY.

70892-0060
SEE NOTE #3 & #5

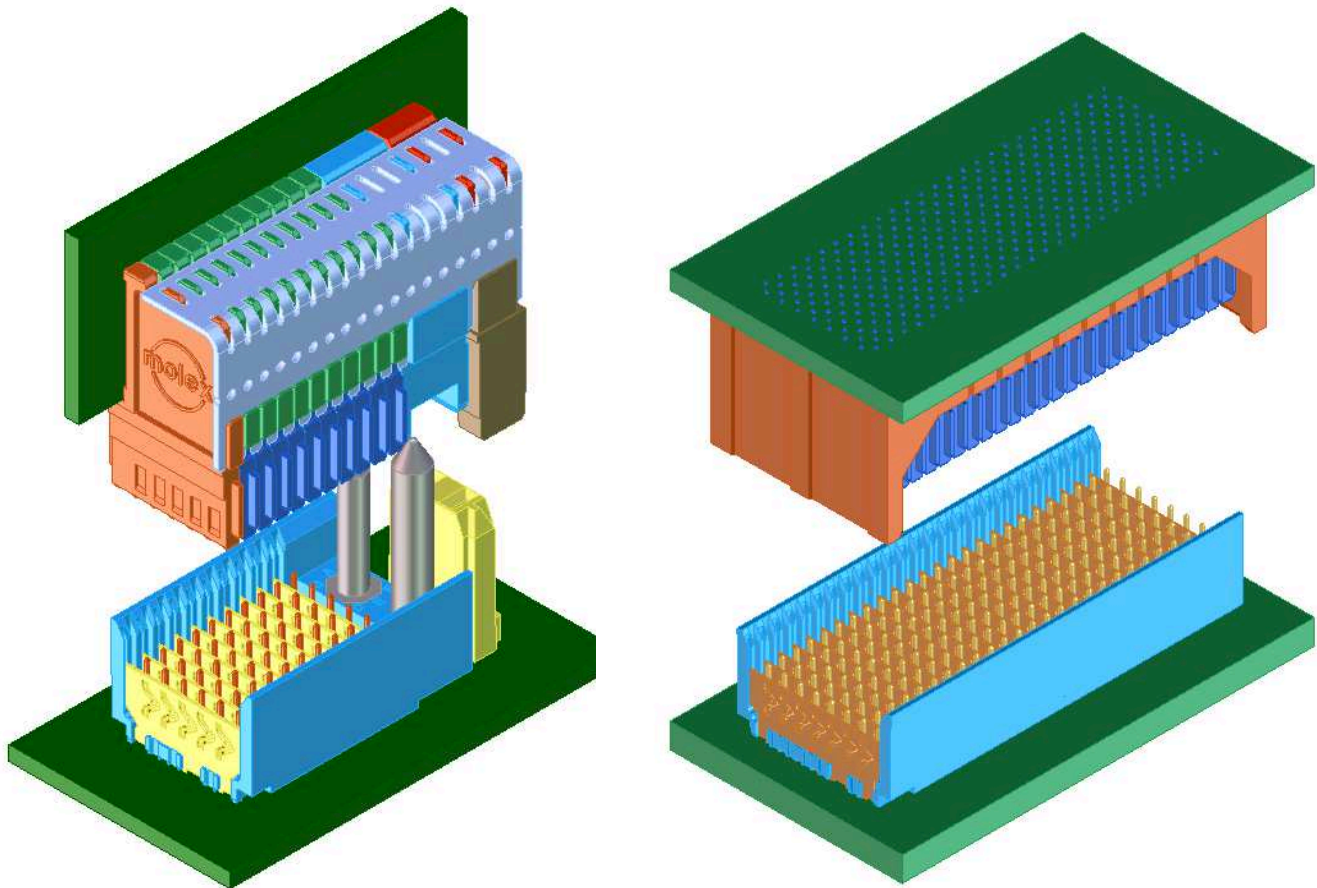
COLUMNS	GUIDE OPTION	PARTS PER TUBE	TUBES PER CARTON	PARTS PER CARTON
6	SINGLE	27	4	108
10	SINGLE	19	4	76
11	SINGLE	17	4	68
12	SINGLE	16	4	64
14	SINGLE	14	4	56
25	SINGLE	9	4	36
7	DUAL	19	4	76
10	DUAL	15	4	60
11	DUAL	14	4	56
12	DUAL	14	4	56
13	DUAL	13	4	52
14	DUAL	12	4	48
20	DUAL	9	4	36
25	DUAL	8	4	32
30	DUAL	7	4	28
35	DUAL	6	4	24

REMOVE ALT PKG NOTE EC NO: UCP2013-2814 DRWN: MWOLFE 2013/01/09 CHKD: SVANG 2013/01/09 APPR: SMILLER 2013/01/14	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY JJONIAK	DATE 2006/03/24	TITLE PACKAGING SPECIFICATION FOR VHDM 6 ROW BACKPLANE WITH GUIDE PIN			
		4 PLACES	± ---	± ---	CHECKED BY JJONIAK	DATE 2006/03/24	molex			
		3 PLACES	± ---	± ---	APPROVED BY JB INGHAM	DATE 2006/03/24				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		ANGULAR ±1/2°		MATERIAL NO. 74058-0030		DOCUMENT NO. PK-74058-003		SHEET NO. 1 OF 1		
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION										



PRODUCT SPECIFICATION

PRODUCT SPECIFICATION FOR VHDM[®], VHDM-H[™] AND VHDM-HSD[™] INTERCONNECT SYSTEMS



VHDM is a registered trademark of Amphenol Corporation.
VHDM-HSD is a trademark of Amphenol Corporation.

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DOCUMENT NUMBER: PS-74031-999	CREATED / REVISED BY: S. VANG	CHECKED BY: M. WOLFE	APPROVED BY: S. MILLER



PRODUCT SPECIFICATION

1.0 SCOPE

This specification covers the performance requirements and test methods for the following products listed by series numbers:

- * 74057, 74058, 74059, 74073, 74074, 74077, 74335, 74336 VHDM 6 Row Backplane Signal Module
- * 74060, 74061, 74062, 74075, 74078, 74457, 74458 VHDM 8 Row Backplane Signal Module
- * 74695, 74696, 74697, 74701, 74702 VHDM-HSD 5 Row Backplane Signal Module
- * 74979, 74980, 74981, 74983, 74984 VHDM-HSD 6 Row Backplane Signal Module
- * 74649, 74650, 74651, 74658, 74659 VHDM-HSD 8 Row Backplane Signal Module
- * 75194, 75195, 75196 VHDM L-Series 6 Row Backplane Signal Module
- * 75197, 75198, 75199 VHDM L-Series 8 Row Backplane Signal Module
- * 76761, 76762, 76763 VHDM H-Series 6 Row Backplane Signal Module
- * 76134, 76135, 76136 VHDM H-Series 8 Row Backplane Signal Module

- * 74029, 75885, 75888 VHDM / VHDM-HSD 5 Row, 6 Row, and 8 Row Backplane Power Module

- * 74030 VHDM 6 Row Daughtercard Assembly
- * 74040 VHDM 8 Row Daughtercard Assembly
- * 74670 VHDM-HSD 5 Row Daughtercard Assembly
- * 74880 VHDM-HSD 6 Row Daughtercard Assembly
- * 74886 VHDM / VHDM-HSD 6 Row Daughtercard Hybrid
- * 74680 VHDM-HSD 8 Row Daughtercard Assembly
- * 74686 VHDM / VHDM-HSD 8 Row Daughtercard Hybrid
- * 75189 VHDM L-Series 6 Row Daughtercard Assembly
- * 75190 VHDM / VHDM-L 6 Row Daughtercard Hybrid
- * 75296 VHDM-HSD / VHDM-L 6 Row Daughtercard Hybrid
- * 75297 VHDM / VHDM-HSD / VHDM-L 6 Row Dcard Tri-brid
- * 75191 VHDM L-Series 8 Row Daughtercard Assembly
- * 75192 VHDM / VHDM-L 8 Row Daughtercard Hybrid
- * 75298 VHDM-HSD / VHDM-L 8 Row Daughtercard Hybrid
- * 75299 VHDM / VHDM-HSD / VHDM-L 6 Row Dcard Tri-brid
- * 76760 VHDM H-Series 6 Row Daughtercard Assembly
- * 76021 VHDM H-Series 8 Row Daughtercard Assembly

(Continued on next sheet)

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PRODUCT SPECIFICATION

- * 74600 VHDM 6 Row Right Angle Male (RAM) Assembly
- * 75165 VHDM 8 Row Right Angle Male (RAM) Assembly
- * 75286 VHDM L-Series 6 Row RAM Assembly
- * 75346 VHDM L-Series 8 Row RAM Assembly
- * 75117 VHDM 8 Row Daughtercard Stacker

The VHDM, VHDM-HSD, VHDM-H and VHDM L-Series backplane interconnect systems consist of 5, 6, and 8 row modular configurations with custom signal, power and guidance modules. These connectors are two-piece devices, which connect two printed circuit boards. The right angle and vertical receptacle connectors (daughtercard) and header pin connectors (backplane) are through hole devices with eye-of-the-needle compliant pin terminals.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAMES

VHDM, VHDM-HSD, VHDM-H and VHDM L-Series

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

Refer to the appropriate sales drawings for information on dimensions, materials, platings and markings.

2.3 SAFETY AGENCY APPROVALS

UL File Number: E29179
 CSA File Number: 152514 (LR19980)

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

Refer to the appropriate sales drawings and other sections of this specification for the necessary referenced documents and specifications.

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PRODUCT SPECIFICATION

4.0 RATINGS

4.1 CURRENT AND TEMPERATURE RATING

Voltage:	120 VAC RMS/DC max
Signal Contact:	1 Amp
Shield Contact (VHDM-HSD 5 Row):	1 Amp
Shield Contact (VHDM-HSD 6/8 Row):	2 Amps
Shield Contact (VHDM 6 Row):	2 Amps
Shield Contact (VHDM 8 row):	3 Amps
Power Contact:	10 Amps per blade
Maximum operating temperature:	105°
Non-operating temperature:	-55°C to 85°C

4.2 SIGNAL CONTACT MATED BULK RESISTANCE (MEASURED VALUES (mOhms))

	6 Row VHDM, H and L- Series	8 Row VHDM, H and L- Series	5 Row VHDM- HSD	6 Row VHDM- HSD	8 Row VHDM- HSD
A Row	5.8	6.9	6.7	5.3	7.8
B Row	5.7	7.5	7.3	6.1	8.3
C Row	7.9	8.4	---	---	---
D Row	8.5	9.9	9.5	8.8	11.3
E Row	9.8	10.4	10.3	9.2	11.5
F Row	10.8	11.8	---	---	---
G Row	---	12.9	---	---	15.2
H Row	---	14.0	---	---	15.5

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PRODUCT SPECIFICATION

5.0 PERFORMANCE

5.1 ELECTRICAL PERFORMANCE

ITEM	TEST CONDITION	REQUIREMENT
CONTACT RESISTANCE (LOW LEVEL)	Mated, 100mA max, 20mV per EIA-364-TP-23	10 milliohm maximum change
INSULATION RESISTANCE	Unmated, 500VDC per EIA-364-TP-21	10,000 megaohms minimum
DIELECTRIC WITHSTANDING VOLTAGE	Unmated, 750VAC per EIA-364-TP-20	No breakdown or flashover
SIGNAL CONTINUITY	Mated per EIA-364-TP-87	No interrupts greater than 10 nanoseconds
COMPLIANT PIN INTERFACE RESISTANCE	Contact inserted into PCB per EIA-364-TP-23	1 milliohm maximum
POWER BLADE CONTACT RESISTANCE	Mated, 10A per EIA-364-TP-06	3 milliohms maximum

REVISION: J	ECR/ECN INFORMATION: EC No: UCP2014-5386 DATE: 2014/07/24	TITLE: PRODUCT SPECIFICATION FOR VHDM, VHDM-H AND VHDM-HSD INTERCONNECT SYSTEMS	SHEET No. 5 of 13
DOCUMENT NUMBER: PS-74031-999	CREATED / REVISED BY: S. VANG	CHECKED BY: M. WOLFE	APPROVED BY: S. MILLER



PRODUCT SPECIFICATION

5.2 MECHANICAL PERFORMANCE

ITEM	TEST CONDITION	REQUIREMENT
SIGNAL WAFER MATING FORCE	Mate daughtercard and backplane assembly per EIA-364-TP-13	40g per signal pin 25g per shield chevron (nominal values) (refer to chart on sheet 7 for maximum expected values)
POWER BLADE MATING FORCE	Mate daughtercard and backplane assembly per EIA-364-TP-13	150g per blade (nominal value)
DURABILITY	200 Cycles, mated and unmated per EIA-364-TP-09	10 milliohm max change in LLCR
VIBRATION	Mated, 10-100Hz, 10g's, 24 hr, 3 axis per EIA-364-TP-28	10 milliohm max change in LLCR
MECHANICAL SHOCK	Mated, 30g half-sine, 11ms, 3 axis per EIA-364-TP-27	10 milliohm max change in LLCR
NORMAL FORCE	Apply perpendicular force to terminal at rate of 25+/-6mm per minute	Signal: 50g min Power: 100g min

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TOTAL CONNECTOR MATING FORCE PER PIN (maximum expected values, standard mate shields)

Product Type	Backplane Pin Length			
	6.25 mm	5.15 mm	4.75 mm	4.25 mm
VHDM 6 Row	85g	100g	100g	100g
VHDM 8 Row	85g	100g	100g	100g
VHDM-H 6 Row	85g	100g	100g	100g
VHDM-H 8 Row	85g	100g	100g	100g
VHDM-HSD 5 Row	85g	100g	100g	100g
VHDM-HSD 6 Row	85g	100g	100g	100g
VHDM-HSD 8 Row	85g	100g	100g	100g
VHDM L-Series 6 Row	85g	85g	85g	85g
VHDM L-Series 8 Row	85g	85g	85g	85g

Note: The values contained in the chart above represent the maximum expected peak mating force for the entire connector normalized to a per pin value. This force value includes all of the typical elements of total connector mating: signal engagement, shield engagement, and plastic engagement. As shown, the 6.25mm pin provides for the lowest total mating force due to the fact that its peak force occurs prior to the engagement of the shield.

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5.3 ENVIRONMENTAL PERFORMANCE

ITEM	TEST CONDITION	REQUIREMENT
THERMAL SHOCK	Mated, 5 cycles from -55°C to 85°C per EIA-364-TP-32	10 milliohm max change in LLCR
TEMPERATURE LIFE	Mated, +105°C for 1000 hours per EIA-364-TP-17	10 milliohm max change in LLCR
HUMIDITY	Mated, 600 hours from +25°C to +65°C per EIA-364-TP-31	10 milliohm max change in LLCR
DUST	Unmated per EIA-364-TP-50	10 milliohm max change in LLCR
MIXED FLOWING GAS	10 days unmated, 10 days mated, per EIA-364-TP-65 and ASTM B827	10 milliohm max change in LLCR

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5.4 COMPLIANT PIN PERFORMANCE

5.4.1 Insertion Force for Various Plating Types (Typical)

COMPONENT	TIN / LEAD		BARE Cu / OSP	
	Typical	Maximum	Typical	Maximum
VHDM / VHDM-HSD Backplane Pin (single pin)	8 lbs	10 lbs	8 lbs	10 lbs
VHDM / VHDM-HSD Backplane Shield (single pin)	4 lbs	6 lbs	4 lbs	8 lbs
VHDM / VHDM-HSD Daughtercard Signal (single pin)	4 lbs	6 lbs	4 lbs	8 lbs
VHDM Daughtercard Shield (single pin)	3 lbs	4 lbs	3 lbs	6 lbs
VHDM-HSD Daughtercard Shield (single pin)	4 lbs	6 lbs	4 lbs	8 lbs
Backplane/Daughtercard Power (single contact with 4 pins)	38 lbs	75 lbs	38 lbs	75 lbs
VHDM-H Series Daughtercard Signal (single pin)	5 lbs	8 lbs	5 lbs	8 lbs
VHDM-H Series Daughtercard Shield (single pin)	5 lbs	8 lbs	5 lbs	8 lbs
VHDM-H Series Backplane Signal (single pin)	5 lbs	8 lbs	5 lbs	8 lbs
VHDM-H Series Backplane Shield (single pin)	5 lbs	8 lbs	5 lbs	8 lbs

Note: "Maximum" columns reflect maximum expected values for insertion forces when tested in plated through holes drilled and plated as described in Section 5.4.3. Plating surface finish and PCB materials will impact actual values.

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5.4.2 Retention Force for Various Plating Types (Typical)

COMPONENT	TIN / LEAD		BARE Cu / OSP	
	Typical	Minimum	Typical	Minimum
VHDM / VHDM-HSD Backplane Pin (single pin)	5.5 lbs	4 lbs	5 lbs	4 lbs
VHDM Backplane Shield (single pin)	3 lbs	1 lb	2 lbs	1 lb
VHDM-HSD Backplane Shield (single pin)	2.5 lbs	1.5 lbs	2 lbs	1.5 lbs
VHDM / VHDM-HSD Daughtercard Signal (single pin)	2.5 lbs	1.5 lbs	2 lbs	1.5 lbs
VHDM Daughtercard Shield (single pin)	2 lbs	1 lb	1.5 lbs	1 lb
VHDM-HSD Daughtercard Shield (single pin)	2.5 lbs	1.5 lbs	2 lbs	1.5 lbs
Backplane/Daughtercard Power (single contact with 4 pins)	25 lbs	10 lbs	22 lbs	10 lbs
VHDM-H Series Daughtercard Signal (single pin)	2 lbs	1.5 lbs	2 lbs	1.5 lbs
VHDM-H Series Daughtercard Shield (single pin)	2 lbs	1.5 lbs	2 lbs	1.5 lbs
VHDM-H Series Backplane Signal (single pin)	2 lbs	1.5 lbs	2 lbs	1.5 lbs
VHDM-H Series Backplane Shield (single pin)	2 lbs	1.5 lbs	2 lbs	1.5 lbs

Note: "Minimum" columns reflect minimum expected values for retention forces when tested in plated through holes drilled and plated as described in Section 5.4.3. Plating surface

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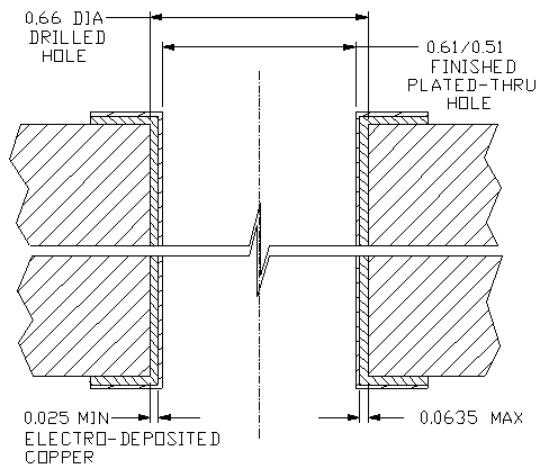
finish and PCB materials will impact actual values.

Radial hole deformation: 1.5 mils max

Axial hole deformation: 1.0 mil max

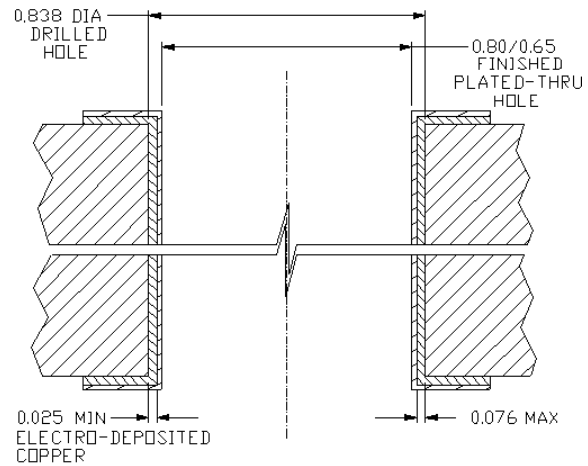
5.4.3 Printed Circuit Board Specifications

Recommended Backplane PCB Thickness:	1.8mm minimum
Recommended Daughtercard PCB Thickness:	1.8mm minimum
VHDM, VHDM-L, & VHDM-HSD Signal/Shield	
Primary Drilled Hole Size:	0.66 mm (#71 Drill)
VHDM-H Signal/Shield	
Primary Drilled Hole Size:	0.57mm (#74 Drill)
Power Primary Drilled Hole Size:	0.838 mm (#66 Drill)



(NOTE: FINISHED HOLE SIZE ALLOWED TO 0.495 MINIMUM FOR HASL FINISHES)

VHDM, VHDM-L, & VHDM-HSD HOLE PLATING DETAIL DAUGHTERCARD OR BACKPLANE SIGNAL AND SHIELD CONTACTS

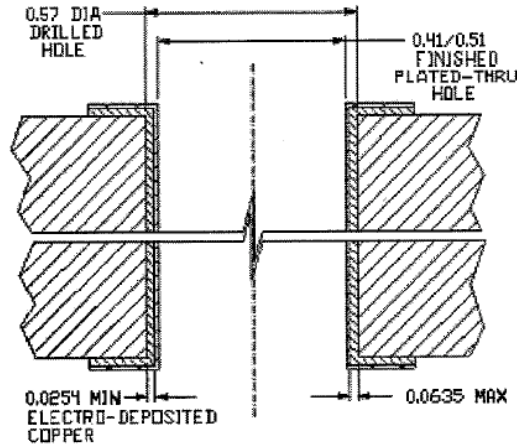


POWER HOLE PLATING DETAIL DAUGHTERCARD OR BACKPLANE POWER CONTACTS

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**H-SERIES HOLE PLATING DETAIL
DAUGHTERCARD OR BACKPLANE
SIGNAL AND SHIELD CONTACTS**

5.4.4 Torque Specification for Mounting Screws

Backplane and Daughtercard Screws:

Screw Type	Board Thickness	Recommended Torque
2-56 Machine Screw	1.8 mm MIN	2.5 +/- 0.5 in-lbs
2-32 Self-Tapping Screw	1.8 mm MIN	*2.5 +/- 0.5 in-lbs

*Note: The thread forming screws used for the daughtercard guidance modules will require varying torque to seat the screw dependent upon the screw engagement in the module. The screw engagement into the module will be impacted by both the screw length and the PCB thickness. It is recommended that the torque applied be the minimum necessary to fully seat the screw for the specific application.

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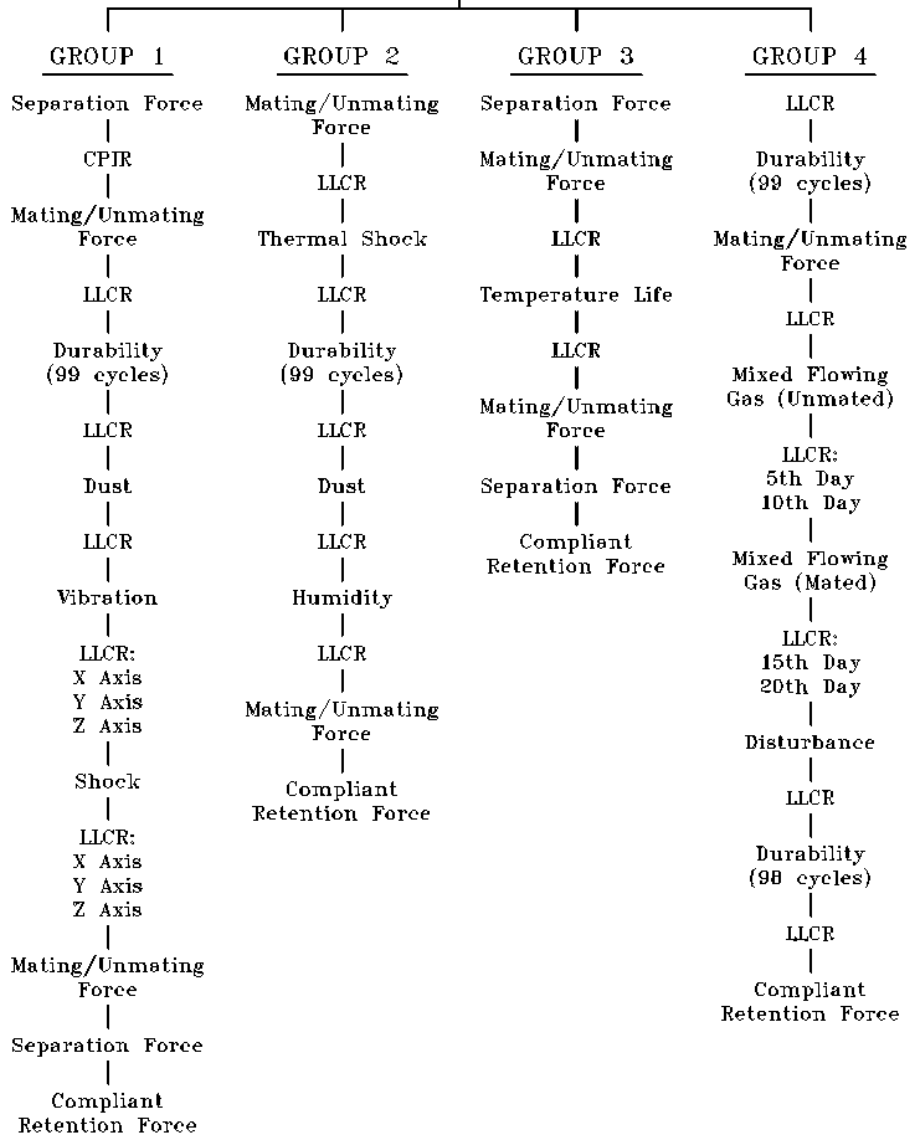


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6.0 TEST SEQUENCE

Bellcore Test Plan

SAMPLE PREPARATION



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